ASSOCIATION CONNEC	Material Compo © Copyright 2005. If international and Pan	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information			
upplier Info									,						
Company name*			Company unique ID			τ	Unique ID Authority				Response Date*				
onsemi											2024-05-04				
Contact Name		Title - Contact			1	Phone - Contact*				Email - Contact*					
Product-Env-Ste	ewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Authorized Representative*			Title - Representative			1	Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Reque	Requester Item Number Mfr Ite		m Number Mfr Item Name				Effective Date	Version	n I	Manufacturing Site		Weight*	UOM	Unit Type	
		NVLJWS6D0N04CLT T6 40V LL 2x2 WD		VDFNW6		2024-05-04		MY1		1	3.571	mg	Each		
<b>Ianufacturi</b> r	ng Proccess Informat	tion													
Terminal Plating / Grid Array Material Te			Cerminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperature   Max Time at Pe		re Max Time at Peak	Temperati	ure Numb	er of Reflow Cyc	cles			
Matte Tin (Sn) - annealed		CU Alloy 1		1		260	C 30		30	second	ds 3				
omments															
vel 1 - maximui	n time at peak temperatu	re during sol	dering is 10-3	0 seconds											
or more inform	ation regarding material (	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	1.987	mg	Supplier	Zinc (Zn)	7440-66-6		0.0024	mg
			Supplier	Iron (Fe)	7439-89-6		0.0467	mg
			Supplier	Copper (Cu)	7440-50-8		1.9373	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0006	mg
Die	0.257	mg	Supplier	Silicon (Si)	7440-21-3		0.257	mg
Die Attach Solder	0.595	mg	Supplier	Silver (Ag)	7440-22-4		0.0149	mg
			A	Lead (Pb)	7439-92-1	7a	0.5504	mg
			Supplier	Tin (Sn)	7440-31-5		0.0298	mg
Lead Frame	5.956	mg	Supplier	Silver (Ag)	7440-22-4		0.3264	mg
			Supplier	Tin (Sn)	7440-31-5		0.0149	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0143	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0155	mg
			Supplier	Copper (Cu)	7440-50-8		5.5849	mg
Mold Compound-Black	4.171	mg	Supplier	Silica Amorphous (SiO2)	7631-86-9		0.3128	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0209	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.3159	mg
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		0.2086	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.3128	mg
Plating	0.6	mg	Supplier	Tin (Sn)	7440-31-5		0.6	mg
Wire Bond	0.005	mg	Supplier	Palladium (Pd)	7440-05-3		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0049	mg